

N-Channel Enhancement Mode Field Effect Transistor

General Description

These miniature surface mount MOSFETs utilize High Cell Density process. Low rDS(on) assures minimal power loss and conserves energy, making this device ideal for use in power management circuitry. Typical applications are DC-DC converters, power management in portable and battery-powered products such as computers, printers, PCMCIA cards, cellular and cordless telephones.

Features

- RDS(ON)<25mΩ @ VGS=4.5V
- RDS(ON)<35mΩ @ VGS=2.5V
- SOT-23-3L Package

Product Summary

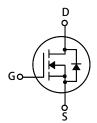
BVDSS	RDSON	ID
20V	25mΩ	6A

Applications

- DC-DC converters
- Power Management in Notebook Computer
- Portable Equipment and Battery Powered Systems

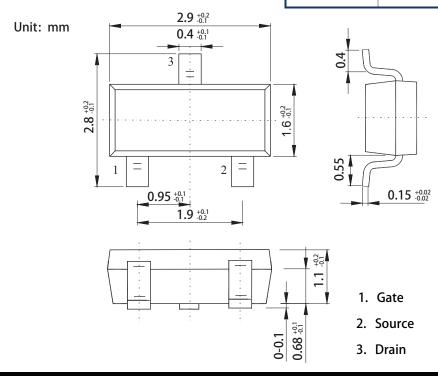
SOT-23-3L Pin Configuration





SO	Г 23	-3I

Туре	Package	Marking		
CMN2300AM	SOT-23-3L	AOD		





N-Channel Enhancement Mode Field Effect Transistor

Absolute Maximum Ratings

Symbol	Parameter	Rating	Units	
V_{DS}	Drain-Source Voltage	20	V	
V_{GS}	Gate-Source Voltage	±8	V	
I _D	Continuous Drain Current 6		А	
I _{DM}	Pulsed Drain Current	18	А	
P _D	Total Power Dissipation	1.25	W	
T _{STG}	Storage Temperature Range -55 to 150		$^{\circ}$ C	
T_J	Operating Junction Temperature Range 150		$^{\circ}$ C	

Thermal Data

Symbol	Parameter	Тур.	Max.	Unit
$R_{\theta JA}$	Thermal Resistance Junction-ambient		100	°C/W

Electrical Characteristics (T_A =25 $^{\circ}$ C , unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV _{DSS}	Drain-Source Breakdown Voltage	V_{GS} =0V , I_D =250uA	20			V
D	Static Drain-Source On-Resistance	V_{GS} =4.5 V , I_D =5.6 A			25	mΩ
$R_{DS(ON)}$	Static Drain-Source On-Resistance	V_{GS} =2.5 V , I_D =4 A			35	11177
V _{GS(th)}	Gate Threshold Voltage	$V_{GS}=V_{DS}$, $I_D=250uA$	0.45		1.2	V
I _{DSS}	Drain-Source Leakage Current	V _{DS} =16V, V _{GS} =0V			1	uA
I _{GSS}	Gate-Source Leakage Current	V _{GS} = ±8V , V _D ₹0V			±100	nA
Qg	Total Gate Charge	I _D =4A		9.2		
Q_{gs}	Gate-Source Charge	V _{DS} = 10V		1.8		nC
Q_{gd}	Gate-Drain Charge	V _{GS} =4.5V		4.5		
$T_{d(on)}$	Turn-On Delay Time			15		
Tr	Rise Time	$V_{DS} = 10V$, $I_{D} = 3.5A$, $R_{G} = 10\Omega$		10		ns
$T_{d(off)}$	Turn-Off Delay Time			55		113
T _f	Fall Time			30		
C _{iss}	Input Capacitance	V _{DS} =10V , V _{GS} =0V , f=1MHz		600		
Coss	Output Capacitance			120		pF
C _{rss}	Reverse Transfer Capacitance			90		

Diode Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
V_{SD}	Diode Forward Voltage	V _{GS} =0V , I _S =0.75A			1.3	V

This product has been designed and qualified for the counsumer market.

Cmos assumes no liability for customers' product design or applications.

Cmos reserver the right to improve product design ,functions and reliability without notice.